ISO/IEC JTC1/SC17 STANDING DOCUMENT 5
(Updated 08 January 2026)

Register of IC manufacturers

Identifier	Company	Country
'01'	Motorola	UK
'02'	STMicroelectronics SA	France
'03'	Hitachi, Ltd.	Japan
'04'	NXP Semiconductors	Germany
'05'	Infineon Technologies AG	Germany
'06'	Cylink	USA
'07'	Texas Instrument	France
'08'	Fujitsu Limited	Japan
'09'	Matsushita Electronics Corporation, Semiconductor Company	Japan
'0A'	NEC	Japan
'0B'	Oki Electric Industry Co. Ltd.	Japan
'0C'	Toshiba Corp.	Japan
'0D'	Mitsubishi Electric Corp.	Japan
'0E'	Samsung Electronics Co. Ltd.	Korea
'0F'	Hynix	Korea
'10'	LG-Semiconductors Co. Ltd.	Korea
'11'	Emosyn-EM Microelectronics	USA
'12'	Wisekey Semiconductors (previously listed as INSIDE Technology)	France
'13'	ORGA Kartensysteme GmbH	Germany
'14'	SHARP Corporation	Japan
'15'	ATMEL	France
'16'	EM Microelectronic-Marin SA	Switzerland
'17'	SMARTRAC TECHNOLOGY GmbH	Germany
'18'	ZMD AG	Germany
'19'	XICOR, Inc.	USA
'1A'	Sony Corporation	Japan
'1B'	Malaysia Microelectronic Solutions Sdn. Bhd	Malaysia

Identifier	Company	Country
'1C'	Emosyn	USA
'1D'	Shanghai Fudan Microelectronics Co. Ltd.	P.R. China
'1E'	Magellan Technology Pty Limited	Australia
'1F'	Melexis NV BO	Switzerland
'20'	Renesas Technology Corp.	Japan
'21'	TAGSYS	France
'22'	Transcore	USA
'23'	Shanghai belling corp., ltd.	China
'24'	Masktech Germany Gmbh	Germany
'25'	Innovision Research and Technology Plc	UK
'26'	Hitachi ULSI Systems Co., Ltd.	Japan
'27'	Yubico AB	Sweden
'28'	Ricoh	Japan
'29'	ASK	France
'2A'	Unicore Microsystems, LLC	Russian Federation
'2B'	Dallas Semiconductor/Maxim	USA
'2C'	Impinj, Inc.	USA
'2D'	RightPlug Alliance	USA
'2E'	Broadcom Corporation	USA
'2F'	MStar Semiconductor, Inc	Taiwan, ROC
'30'	BeeDar Technology Inc.	USA
‘31’	RFIDsec	Denmark
‘32’	Schweizer Electronic AG	Germany
‘33’	AMIC Technology Corp	Taiwan
‘34’	Mikron JSC	Russia
‘35’	Fraunhofer Institute for Photonic Microsystems	Germany
‘36’	IDS Microchip AG	Switzerland
‘37’	Kovio	USA
‘38’	HMT Microelectronic Ltd.	Switzerland
'39'	Silicon Craft Technology	Thailand
‘3A’	Advanced Film Device Inc.	Japan

Identifier	Company	Country
‘3B’	Nitecrest Ltd.	UK
‘3C’	Verayo Inc.	USA
'3D'	HID Global	USA
‘3E’	Productivity Engineering Gmbh	Germany
‘3F’	Austriamicrosystems AG (reserved)	Austria
‘40’	Thales DIS (previously listed as Gemalto SA France)	France
‘41’	Renesas Electronics Corporation	Japan
'42'	3Alogics Inc	Korea
'43'	Top TroniQ Asia Limited	Hong Kong
'44'	Gentag Inc (USA)	USA
‘45’	Invengo Information Technology Co. Ltd.	China
‘46’	Guangzhou Sysur Microelectronics, Inc	China
‘47’	CEITEC S.A.	Brazil
‘48’	Shanghai Quanray Electronics Co. Ltd.	China
‘49’	MediaTek Inc	Taiwan
‘4A’	Angstrem PJSC	Russia
‘4B’	Celisic Semiconductor (Hong Kong) Limited	China
‘4C’	LEGIC Identsystems AG	Switzerland
‘4D’	Balluff GmbH	Germany
‘4E’	Oberthur Technologies	France
‘4F’	Silterra Malaysia Sdn. Bhd.	Malaysia
‘50’	Presto Engineering	Denmark
‘51’	Giesecke & Devrient GmbH	Germany
‘52’	Shenzhen China Vision Microelectronics Co., Ltd.	China
‘53’	Shanghai Feiju Microelectronics Co. Ltd.	China
‘54’	Intel Corporation	USA
‘55’	Microsensys GmbH	Germany
‘56’	Sonix Technology Co., Ltd.	Taiwan
‘57’	Qualcomm Technologies Inc	USA
‘58’	Realtek Semiconductor Corp	Taiwan
‘59’	Freevision Technologies Co. Ltd.	China
‘5A’	Giantec Semiconductor Inc.	China

Identifier	Company	Country
‘5B’	JSC Angstrem-T	Russia
‘5C’	STARCHIP	France
‘5D’	SPIRTECH	France
‘5E’	GANTNER Electronic GmbH	Austria
‘5F’	Nordic Semiconductor	Norway
‘60’	Verisiti Inc	USA
‘61’	Wearlinks Technology Inc.	China
‘62’	Userstar Information Systems Co., Ltd.	Taiwan
‘63’	Pragmatic Semiconductor Ltd.	UK
‘64’	Associação do Laboratório de Sistemas Integráveis Tecnológico – LSI-TEC	Brazil
‘65’’	Tendyron Corporation	China
‘66’	MUTO Smart Co., Ltd.	Korea
‘67’	ON Semiconductor	USA
‘68’	TÜBİTAK BİLGEM	Turkey
‘69’	Huada Semiconductor Co., Ltd.	China
‘6A’	SEVENEY	France
‘6B’	THALES DIS Design Services SAS (Previously listed as ISSM)	France
‘6C’	Wisesec Ltd	Israel
'6D'	LTD "NM-Teh"	Russia
'6E'	to be defined	
'6F'	to be defined	
'70'	ifm electronic gmbh	Germany
'71'	Sichuan Kiloway Technologies Co., Ltd.	China
‘72’	Ford Motor Company	US
‘73’	Beijing Tsingteng MicroSystem Co.,Ltd	China
‘74’	Huada EverCore Co., Ltd	China
‘75’	Smartchip Microelectronics Corporation	Taiwan
‘76’	Tongxin Microelectronics Co., Ltd.	China
‘77’	Ningbo IOT Microelectronics Co Ltd.	China
‘78’	AU Optronics	Taiwan
‘79’	CUBIC	USA

Identifier	Company	Country
‘7A’	Abbott Diabetes Care	USA
‘7B’	Shenzen Nation RFID Technology Co Ltd.	China
‘7C’	DB HiTek Co Ltd	Korea
‘7D’	SATO Vicinity	Australia
‘7E’	Holtek	Taiwan
‘FF 00’	Shenzhen Goodix Technology Co., Ltd.	China
‘FF 01’	Panthronics AG	Austria
‘FF 02’	Beijing Huada Infosec Technology Co., Ltd.	China
‘FF 03’	Shanghai Oriental Magnetic Card Engineering Co Ltd.	China
‘FF 04’	8ApeX Inc	USA
‘FF 05’	Abbott	Ireland
‘FF 06’	Proqure Inc	USA
‘FF 07’	Schreiner Group GmbH & Co. KG	Germany
‘FF 08’	Beijing SmartChip Microelectronics Technology Company Limited	China
‘FF 09’	Datang Microelectronics Technology Co., Ltd.	China
‘FF 0A’	Wise Security Technology (Guangzhou) Co., Ltd.	China
‘FF 0B’	CEC Huada Electronic Design Co., Ltd.	China
‘FF 0C’	Shanghai Techsun RFID Technology Co., Ltd.	China
‘FF 0D’	North China Institute of Computing Technology	China
‘FF 0E’	Shanghai Huahong Integrated Circuit Co., Ltd.	China
‘FF 0F’	Shanghai MintSilicon Microelectronics Inc., Ltd.	China
‘FF 10’	Xinsheng Technology Co., Ltd.	China
‘FF 11’	IDEX Biometrics ASA	Norway
‘FF 12’	Novo Nordisk A/S	Denmark
‘FF 13’	Shandong Huayi Micro-Electronics Technology Co., Ltd.	China
‘FF 14’	Abbott Heart Failure	USA
‘FF 15’	P&M Information Technology (Shenzhen) Co., Ltd.	China
‘FF 16’	MARS TECHNOLOGY PTE. LTD.	Singapore
‘FF 17’	Trovan Limited	Isle of Man
‘FF 18’	Beijing NJA Information Tehnology Co., Ltd.	China
‘FF 19’	tatwah SA	Switzerland
‘FF 1A’	L&T Semiconductor Technologies Ltd.	India

Identifier	Company	Country
‘FF 1B’	Tianjin C*Core Technology Co., Ltd.	China

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